

# **Challenges and prospects for the Silicon Tracking System** of CBM in the first tests with heavy ions collisions

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# STS for the CBM experiment





- track point measurement in high-rate collision environment:
  - $10^{5} 10^{7}$ /s (A+A), up to  $10^{9}$ /s (p+A)
- physics aperture :  $2.5^{\circ} \le \Theta \le 25^{\circ}$
- 8 tracking stations built with double-sided silicon microstrip sensors
- self-triggering front-end electronics
- material :  $\approx 0.4\% 1.4\% X_0$  per station

# Silicon sensors

### **Double-sided n-type silicon sensors**

- Thickness:  $320 \,\mu\text{m} \pm 15 \,\mu\text{m}$
- 58 μm pitch
- 1024 strips/side
- strip length 2/4/6/12 cm
- 7.5° stereo angle for p-side strips (suppression of the ghost track rate)
- double-metal routing on p-side

• hit spatial resolution  $\approx 25 \,\mu m$ 

**STS-XYTER ASIC** 

**STS** + **X**, **Y** coordinates

Time and Energy Resolution

128 readout channels

time resolution < 5 ns

(14 fC dynamic range)

radiation hard layout

**Detector module as functional unit:** 

2 front-end boards (16 ASICs)

stack of polyamide readout cables

silicon sensor

5 bit flash ADC/channel

hit rate/channel: >250 kHz

- $\Delta p/p \approx 1.8\%$  (p > 1 GeV/c, 1 Tm field)
- track (> 1 GeV/c) and single hit reconstruction efficiency 96% and 98%
- radiation tolerance: NIEL:  $1 \times 10^{14} n_{eq} (1 \text{ MeV}) / \text{cm}^2$ TID: 1 Mrad
- sensors developed and produced by Hamamatsu/Japan

# Front-end electronics & STS module



Block diagram of the STS-XYTER ASIC

## STS readout chain CBM Experimental Hall

**CBM** Service building Cube ~100 m ~700 m FEB Timeslice Building ROB & FLES FEB . . . FEB FLES InfiniBand PCle CRI DATA DATA input node ROB FEB GBT links Clock, Sync commands, "busy" status FEB ROB FEB Detector Timing & **Electrical link** Slow Control Fast Control Optical link

Block diagram of the STS readout chain

**STS detector in numbers:** 

- 896 detector modules
- 106 ladders
- 1.6 million readout channels



High performance, free-streaming readout chain Main components: **FEB:** Front-end boards **ROB:** Readout board **CRI:** Common readout interface

**TFC:** Timing and fast control **DSC:** Detector slow control FLES: First level event selector

Green IT

# mCBM @ SIS18: First tests with heavy-ions collisions

### **CBM** full test setup for high rate, nucleus-nucleus collisions at GSI/FAIR **GOALS:**

- demonstrator for full CBM data taking and analysis
- integrating prototype detector's modules into a common, free-streaming DAQ
- reconstructing physics observable (A reconstruction using Ni-Ni at 1.93 AGeV and Au+Au at 1.24 AGeV)

### **STS GETTING READY (mSTS) GOALS:**

- operation of full STS modules in a high-rate heavy-ion data taking scenario
- 13 STS sensor modules grouped in 2 tracking stations (5 ladders)
- 208 STS-XYTER ASICs (~26600 readout channels)





### **Preliminary results from March 2019 run**

- 2 detector ladder with 4 modules installed
- Ag+Au collisions at 1.58 AGeV.
- Up to 10<sup>7</sup> ions/s in a 1% and 10% interaction target



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### **Key participant institutes:**

GSI (Darmstadt, Germany), JINR (Dubna, Russia), Univ. Tübingen (Germany), KIT (Karlsruhe, Germany), AGH (Krakow, Poland), JU (Krakow, Poland), WUT (*Warsaw, Poland*), Goethe University (*Frankfurt, Germany*)

### **Timeline:**

Detector construction: 2020– 2025 Assembly Centers: GSI-FAIR, JINR-VBLHEP, KIT

